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(54) Title: CURABLE DIELECTRIC POLYNORBORNENE COMPOSITION AND CIRCUIT BOARDS MADE THEREFROM

(57) Abstract: The present invention relates to a curable dielectric composition comprising polynorbornene, a polymeric diluent that plasticises the composition, a particulate material and a curing agent for the composition. The present invention also relates to a cured form of the curable composition and an electronic circuit board including a cured form of the composition upon which is mounted an electronic circuit.